

# MALD068XG

## Silicon planar type

For ESD protection

### ■ Overview

MALD068XG is optimal for cell phones and AV application, all types of I/O circuits.

It is possible to protect against forward and reverse surges.

### ■ Features

- High resistance to surge voltages: 20 kV guaranteed
- Low terminal capacitance  $C_t$  for low loss, low distortion, and good retention of signal waveforms.

### ■ Package

- Code  
SSSMINI2-F3
- Pin Name  
1: Cathode  
2: Cathode

### ■ Marking Symbol: A

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Peak pulse current *1	$I_{PP}$	3	A
Peak pulse power *1	$P_{PP}$	33	W
Total power dissipation *2	$P_T$	150	mW
Junction temperature *3	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$
Electrostatic discharge	ESD	$\pm 20$	kV

Note) \*1: Test method: IEC61000-4-5 ( $t_p = 8/20 \mu\text{s}$ , Unrepeated)

\*2: Test method: IEC61000-4-2 ( $C = 150 \text{ pF}$ ,  $R = 330 \Omega$ , Contact discharge: 10 times)

\*3:  $P_T = 150 \text{ mW}$  achieved with a printed circuit board.

### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

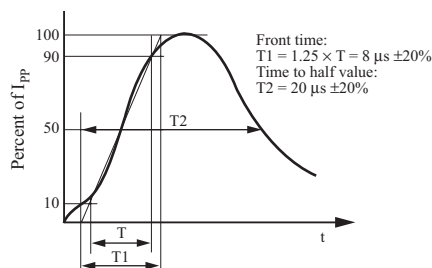
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Breakdown voltage *1	$V_{BR}$	$I_Z = 5 \text{ mA}$	5.8	7.2	8.8	V
Clamping voltage *2	$V_C$	$I_{PP} = 3.0 \text{ A}$ , $t_p = 8/20 \mu\text{s}$			11.0	$\Omega$
Reverse current	$I_R$	$V_R = 3.5 \text{ V}$			500	nA
Terminal capacitance	$C_t$	$V_R = 0 \text{ V}$ , $f = 1 \text{ MHz}$		25		pF

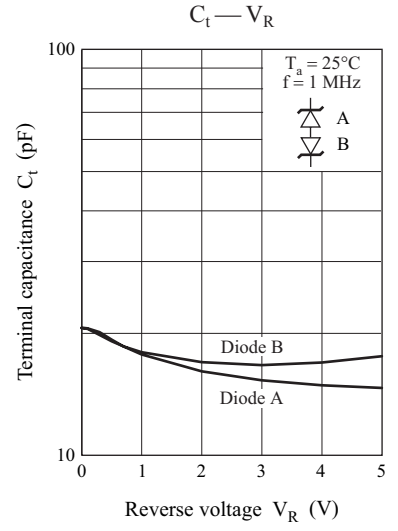
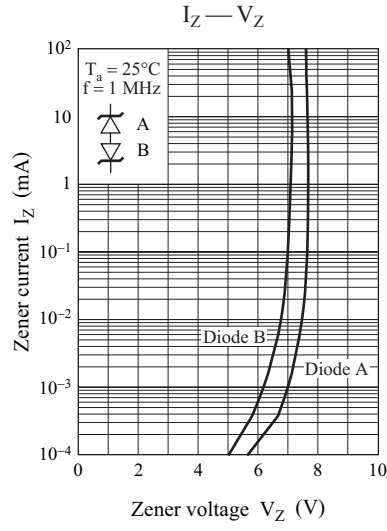
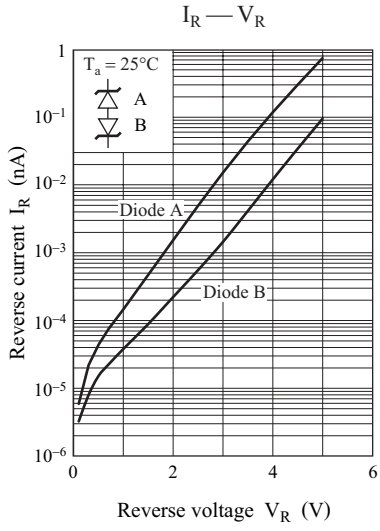
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. \*1:  $V_{BR}$  guaranteed 20 ms after current flow.

\*2: Pulse Waveform

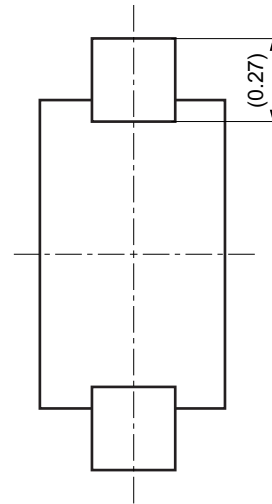
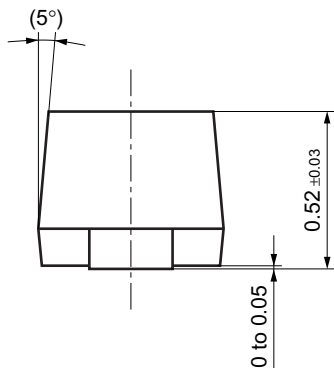
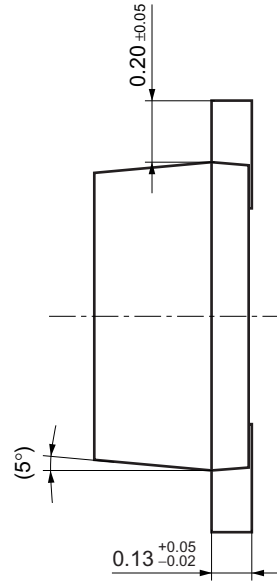
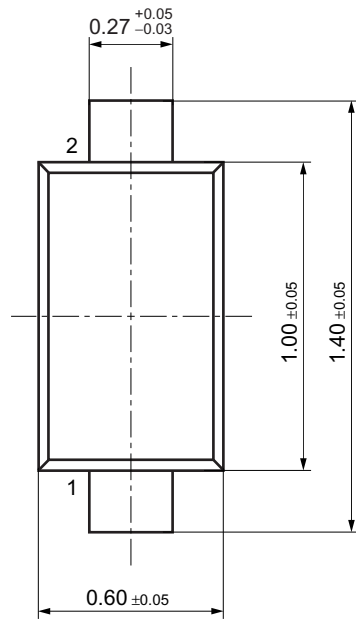
3. Absolute frequency of input and output is 5 MHz





SSSMini2-F3

Unit: mm



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